# XP133A1235SR



ETR1112 001a

#### **Power MOSFET**

#### ■GENERAL DESCRIPTION

The XP133A1235SR is an N-channel Power MOSFET with low on-state resistance and ultra high-speed switching characteristics. Two FET devices are built into the one package

Because high-speed switching is possible, the IC can be efficiently set thereby saving energy.

The small SOP-8 package makes high density mounting possible.

#### ■APPLICATIONS

- ■Notebook PCs
- Cellular and portable phones
- On-board power supplies
- Li-ion battery systems

#### **■**FEATURES

**Low On-State Resistance** : Rds(on)= $0.035 \Omega$  (Vgs= 4.5V)

: Rds(on)=0.048  $\Omega$  (Vgs = 2.5V)

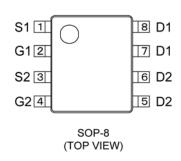
Ultra High-Speed Switching
Driving Voltage : 2.5V
N-Channel Power MOSFET

**DMOS Structure** 

Two FET Devices Built-in

Package : SOP-8

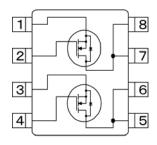
#### **■ PIN CONFIGURATION**



#### ■ PIN ASSIGNMENT

PIN NUMBER	PIN NAME	FUNCTION
1	S1	Source
2	G1	Gate
3	S2	Source
4	G2	Gate
5~6	D2	Drain
7~8	D1	Drain

## **■**EQUIVALENT CIRCUIT



N-channel MOSFET ( 2 FET devices built-in )

#### ■ ABSOLUTE MAXIMUM RATINGS

Ta = 25°C

PARAMETER	SYMBOL	RATINGS	UNITS
Drain-Source Voltage	Vdss	20	V
Gate-Source Voltage	Vgss	±12	V
Drain Current (DC)	ld	6	Α
Drain Current (Pulse)	ldp	20	Α
Reverse Drain Current	ldr	6	Α
Channel Power Dissipation *	Pd	2	W
Channel Temperature	Tch	150	°C
Storage Temperature Range	Tstg	-55~150	°C

<sup>\*</sup> When implemented on a glass epoxy PCB

## **■**ELECTRICAL CHARACTERISTICS

DC Characteristics Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Drain Cut-Off Current	ldss	Vds=20V, Vgs=0V	-	-	10	μΑ
Gate-Source Leak Current	lgss	Vgs=±12V, Vds=0V	-	-	±1	μΑ
Gate-Source Cut-Off Voltage	Vgs(off)	Id=1mA, Vds=10V	0.5	-	1.2	V
Drain-Source On-State Resistance *	Rds(on)	Id=3A, Vgs=4.5V	-	0.026	0.035	Ω
		Id=3A, Vgs=2.5V	-	0.035	0.048	Ω
Forward Transfer Admittance *	Yfs	Id=4A, Vds=10V	-	14	-	S
Body Drain Diode Forward Voltage	Vf	If=6A, Vgs=0V	-	0.85	1.1	٧

<sup>\*</sup> Effective during pulse test.

#### **Dynamic Characteristics**

Ta = 25°C

PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input Capacitance	Ciss		-	760	-	pF
Output Capacitance	Coss	Vds=10V, Vgs=0V f=1MHz	-	430	-	pF
Feedback Capacitance	Crss	1 11/11/2	-	200	-	pF

#### **Switching Characteristics**

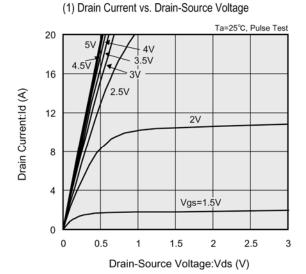
Ta = 25°C

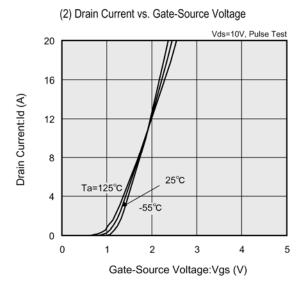
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PARAMETER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-On Delay Time	td (on)	Vgs=5V, Id=3A Vdd=10V	ı	10	ı	ns
Rise Time	tr		-	20	-	ns
Turn-Off Delay Time	td (off)		-	55	-	ns
Fall Time	tf		-	15	-	ns

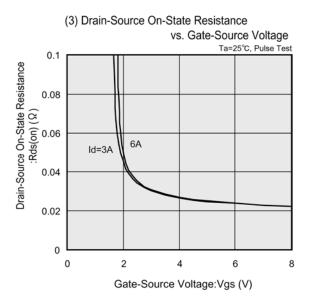
#### **Thermal Characteristics**

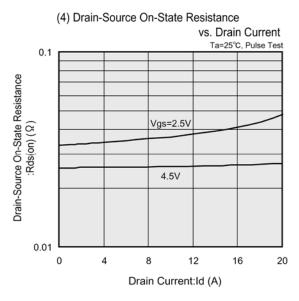
PARAM	METER	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Thermal F (Channel-	esistance Ambience)	Rth (ch-a)	Implement on a glass epoxy resin PCB	-	62.5	-	°C/W

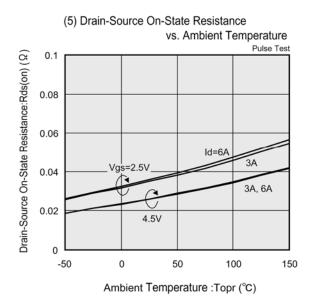
### **■TYPICAL PERFORMANCE CHARACTERISTICS**

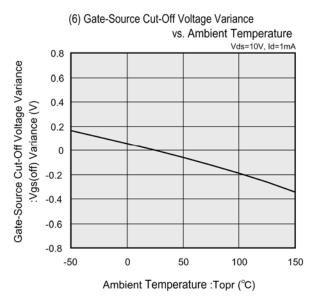




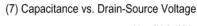


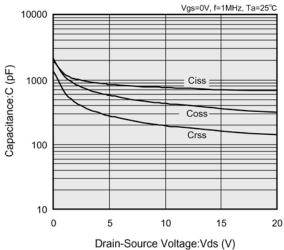




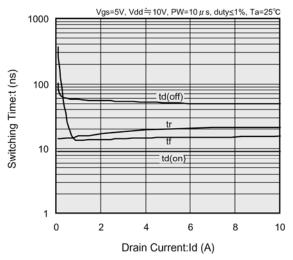


## ■TYPICAL PERFORMANCE CHARACTERISTICS (Continued)

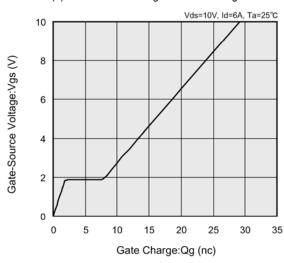




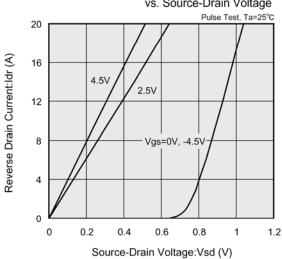
#### (8) Switching Time vs. Drain Current



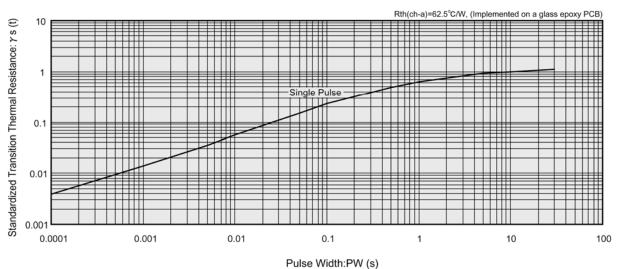
#### (9) Gate-Source Voltage vs. Gate Charge



## (10) Reverse Drain Current vs. Source-Drain Voltage



#### (11) Standardized transition Thermal Resistance vs. Pulse Width



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